CLAIMS

[Claim 1]

A resin sheet for molding comprising:

a base material sheet; and

a surface layer provided on at least one surface of the base material sheet and including silicone,

wherein the silicone content in the surface layer is 0.3 to 4.0 g/m^2, and

wherein the base material sheet is formed of a resin composition including 29 to 65 parts by mass of a Styrene-conjugated diene block copolymer (A), 25 to 60 parts by mass of a polystyrene resin (B), and 8 to 20 parts by mass of a high-impact polystyrene resin (C) in terms of proportions provided that a total amount of the component (A), the component (B), and the component (C) is 100 parts by mass.

[Claim 2]

The resin sheet according to claim 1,

wherein the surface layer includes at least one kind of silicone oil selected from the group consisting of dimethylsilicone oil, methylphenyl silicone oil, methylhydrogen silicone oil, and modified silicone oil.

[Claim 3]

The resin sheet according to claim 1,

wherein the surface layer includes modified silicone oil having at least one kind of group selected from the group consisting of a hydroxyl group, a phenol group, and a carboxyl group.

[Claim 4]

The resin sheet according to any one of claims 1 to 3,

wherein the surface layer further includes a conductive material.

[Claim 5]

A method of manufacturing the resin sheet according to any one of claims 1 to 4 comprising:

a step of forming the surface layer by coating at least one surface of the base material sheet with a coating liquid including the silicone and drying the coated surface such that an adhesion amount of the dried silicone becomes 0.3 to 4.0 g/m^2.

[Claim 6]

A container that is a molded body of the resin sheet according to any one of claims 1 to 4.

[Claim 7]

The container according to claim 6,

wherein the container has a part molded into a recessed shape having a bottom wall portion and side wall portions standing from a circumferential edge of the bottom wall portion, and a drawing ratio DR of the part calculated by the following Expression (1) is 3.5 or larger.

DR=IA/OA ... (1)

[in Expression (1), IA indicates a total area of inner side surfaces of the bottom wall portion and the side wall portions, and OA indicates an opening area of the recessed shape]

[Claim 8]

A carrier tape that is a molded body of the resin sheet according to any one of claims 1 to 4,

wherein an accommodation portion capable of accommodating an article is provided.

[Claim 9]

The carrier tape according to claim 8,

wherein the accommodation portion is provided in a recessed shape having a bottom wall portion and side wall portions standing from a circumferential edge of the bottom wall portion, and a drawing ratio DR of the accommodation portion calculated by the following Expression (2) is 3.5 or larger.

DR=IA/OA ... (2)

[in Expression (2), IA indicates a total area of inner side surfaces of the bottom wall portion and the side wall portions, and OA indicates an opening area of the recessed shape]

[Claim 10]

An electronic component packaging body comprising:

the carrier tape according to claim 8 or 9;

an electronic component accommodated in the accommodation portion of the carrier tape; and

a cover film adhered to the carrier tape as a lid material.